



503.43552X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: SHIBATA et al

Serial No.: 10/797,003

Filed: March 11, 2004

For: Mold Die And Method For Manufacturing Semiconductor  
Device Using The Same

Art Unit: 2814

Examiner: Chambliss, A.

**RESPONSE TO NON COMPLIANT AMENDMENT**

Commissioner For Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

February 13, 2006

Sir:

This is in response to the Notice of Non-Compliant Office Action mailed January 13, 2006, in connection with the above-identified application, Applicants enclose herewith Figures 9-12 marked Replacement Sheets.

To the extent necessary, applicants petition for an extension of time under 37 CFR 1.136. Please charge any shortage in the fees due in connection with the filing of this paper, including extension of time fees, to the deposit account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (Case: 501.43552X00), and please credit any excess fees to such deposit account.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

  
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